

# PC3Q64Q

## Mini-flat Package AC Input Type Half Pitch Photocoupler

### ■ Features

1. AC input type
2. Half pitch type (lead pitch : 1.27mm)
3. Isolation voltage between input and output  
( $V_{iso} : 2\,500V_{rms}$ )
4. Applicable to infrared ray reflow  
( $230^{\circ}C$ , for MAX. 30 seconds)
5. High reliability

### ■ Applications

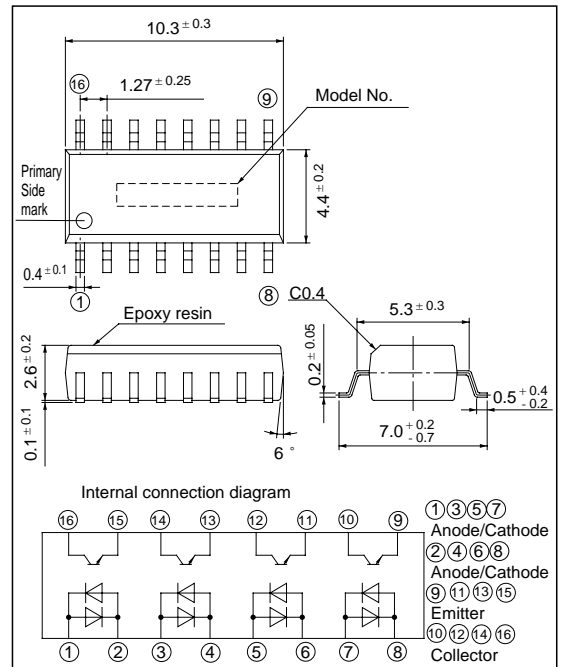
1. Programmable controllers

### ■ Package Specifications

Model No.	Package specification
<b>PC3Q64Q</b>	Taping reel diameter 330mm ( 1 000pcs )

### ■ Outline Dimensions

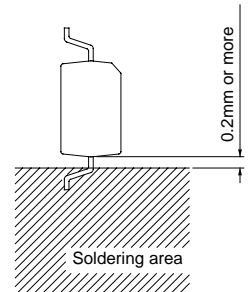
(Unit : mm )



### ■ Absolute Maximum Ratings

(Ta = 25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	$\pm 50$	mA
	*1 Peak forward current	$I_{FM}$	$\pm 1$	A
	Power dissipation	P	70	mW
Output	Collector-emitter voltage	$V_{CEO}$	35	V
	Emitter-collector voltage	$V_{ECO}$	6	V
	Collector current	$I_C$	50	mA
	Collector power dissipation	$P_C$	150	mW
	Total power dissipation	$P_{tot}$	170	mW
*2 Isolation voltage		$V_{iso}$	2.5	kV <sub>rms</sub>
Operating temperature		$T_{opr}$	- 30 to + 100	°C
Storage temperature		$T_{stg}$	- 40 to + 125	°C
*3 Soldering temperature		$T_{sol}$	260	°C

\*1 Pulse width  $\leq 100\mu s$ , Duty ratio : 0.001

\*2 AC for 1 min., 40 to 60% RH, f = 60Hz

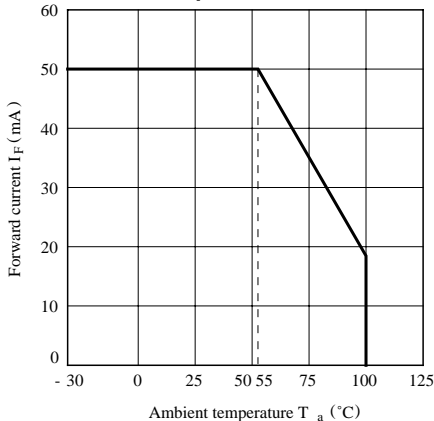
\*3 For 10 seconds

**Electro-optical Characteristics**

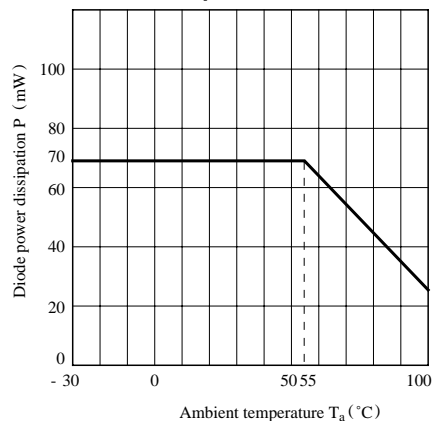
( $T_a = 25^\circ\text{C}$ )

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	$V_F$	$I_F = \pm 20\text{mA}$	-	1.2	1.4	V
	Terminal capacitance	$C_t$	$V = 0, f = 1\text{kHz}$	-	30	250	pF
Output	Collector dark current	$I_{CEO}$	$V_{CE} = 20\text{V}, I_F = 0$	-	-	100	nA
	Collector-emitter breakdown voltage	$BV_{CEO}$	$I_C = 0.1\text{mA}$ $I_F = 0$	35	-	-	V
	Emitter-collector breakdown voltage	$BV_{ECO}$	$I_E = 10\mu\text{A}, I_F = 0$	6	-	-	V
Transfer characteristics	Collector current	$I_C$	$I_F = \pm 1\text{mA}$ $V_{CE} = 5\text{V}$	0.2	-	4.0	mA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F = \pm 20\text{mA}$ $I_C = 1\text{mA}$	-	0.1	0.2	V
	Isolation resistance	$R_{ISO}$	DC500V 40 to 60% RH	$5 \times 10^{10}$	$10^{11}$	-	$\Omega$
	Floating capacitance	$C_f$	$V = 0, f = 1\text{MHz}$	-	0.6	1.0	pF
	Response time	Rise time	$t_r$	$V_{CE} = 2\text{V}$ $I_C = 2\text{mA}$ $R_L = 100\Omega$	-	4	18
Fall time		$t_f$	-		3	18	$\mu\text{s}$

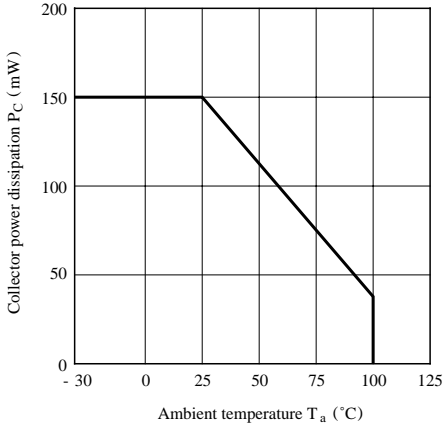
**Fig. 1 Forward Current vs. Ambient Temperature**



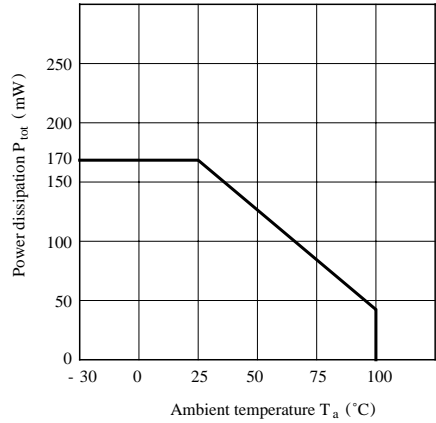
**Fig. 2 Diode Power Dissipation vs. Ambient Temperature**



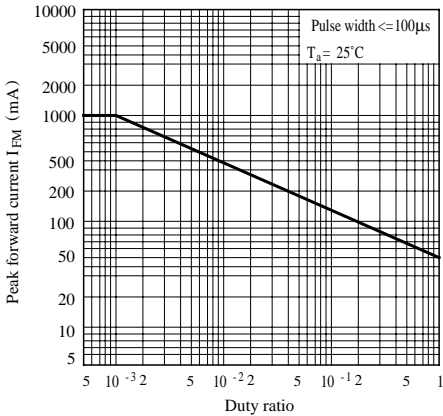
**Fig. 3 Collector Power Dissipation vs. Ambient Temperature**



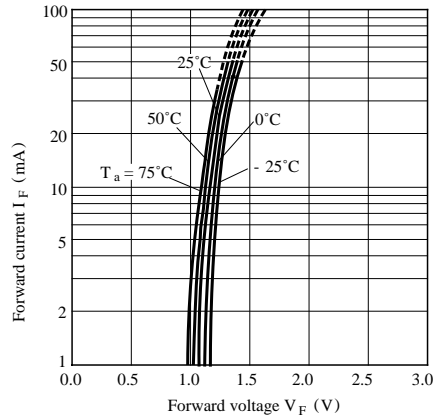
**Fig. 4 Power Dissipation vs. Ambient Temperature**



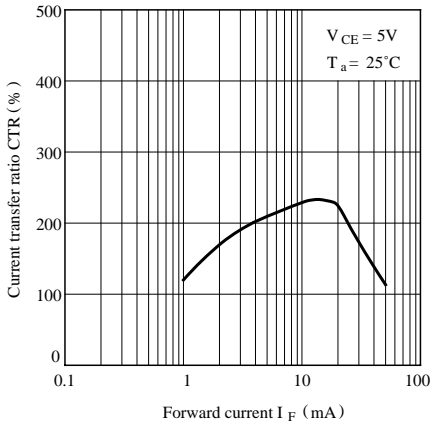
**Fig. 5 Peak Forward Current vs. Duty Ratio**



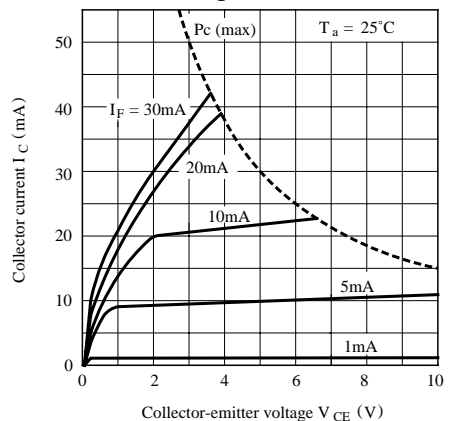
**Fig. 6 Forward Current vs. Forward Voltage**



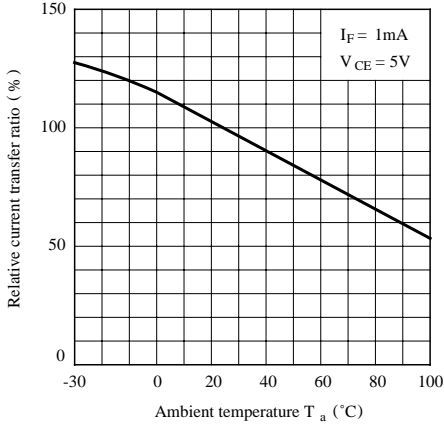
**Fig. 7 Current Transfer Ratio vs. Forward Current**



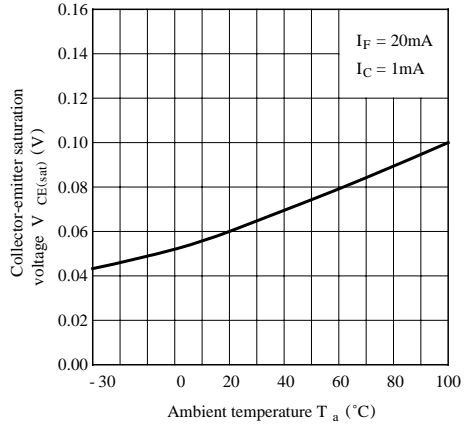
**Fig. 8 Collector Current vs. Collector-emitter Voltage**



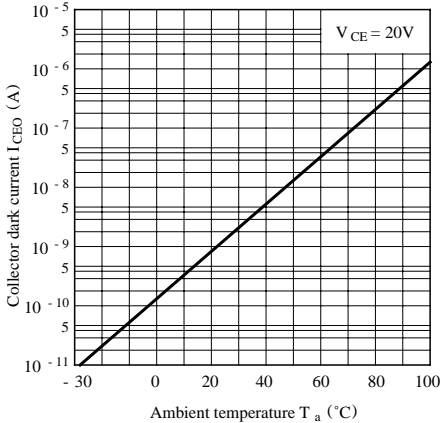
**Fig. 9 Relative Current Transfer Ratio vs. Ambient Temperature**



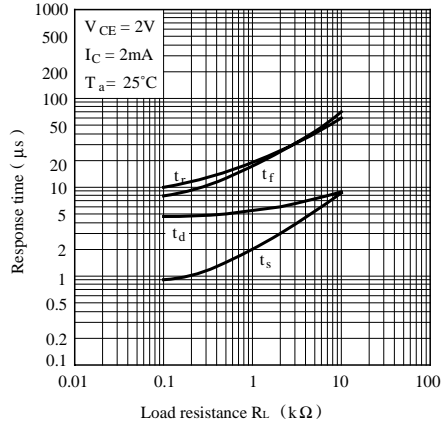
**Fig.10 Collector-emitter Saturation Voltage vs. Ambient Temperature**



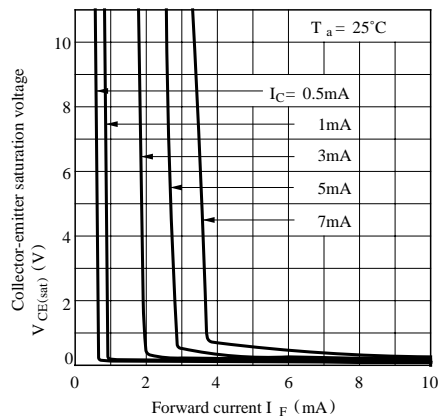
**Fig.11 Collector Dark Current vs. Ambient Temperature**



**Fig.12 Response Time vs. Load Resistance**



**Fig.13 Collector-emitter Saturation Voltage vs. Forward Current**



●Please refer to the chapter  
“Precautions for Use.”

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